

< C band internally matched power GaAs FET >

# MGFC42V3742

3.7 – 4.2 GHz BAND / 16W

## DESCRIPTION

The MGFC42V3742 is an internally impedance-matched GaAs power FET especially designed for use in 3.7 – 4.2 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

## FEATURES

Class A operation

Internally matched to 50(ohm) system

- High output power  
P1dB=16W (TYP.) @f=3.7 – 4.2GHz
- High power gain  
GLP=11dB (TYP.) @f=3.7 – 4.2GHz
- High power added efficiency  
P.A.E.=32% (TYP.) @f=3.7 – 4.2GHz
- Low distortion [item -51]  
IM3=-45dBc (TYP.) @Po=31dBm S.C.L

## APPLICATION

- item 01 : 3.7 – 4.2 GHz band power amplifier
- item 51 : 3.7 – 4.2 GHz band digital radio communication

## QUALITY

- IG

## RECOMMENDED BIAS CONDITIONS

- VDS=10V • ID=4.5A • RG=25ohm Refer to Bias Procedure

## Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain breakdown voltage	-15	V
VGSO	Gate to source breakdown voltage	-15	V
ID	Drain current	15	A
IGR	Reverse gate current	-40	mA
IGF	Forward gate current	84	mA
PT *1	Total power dissipation	78.9	W
Tch	Channel temperature	175	°C
Tstg	Storage temperature	-65 to +175	°C

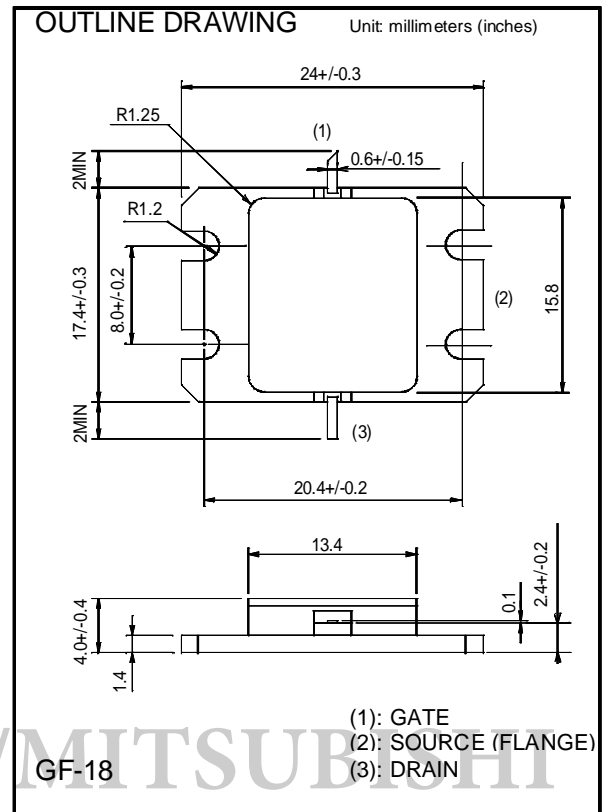
\*1 : Tc=25°C

## Electrical characteristics (Ta=25°C)

Symbol	Parameter	Test conditions	Limits			Unit	
			Min.	Typ.	Max.		
IDSS	Saturated drain current	VDS=3V, VGS=0V	-	9	12	A	
gm	Transconductance	VDS=3V, ID=4.4A	-	4	-	S	
VGS(off)	Gate to source cut-off voltage	VDS=3V, ID=80mA	-2	-3	-4	V	
P1dB	Output power at 1dB gain compression	VDS=10V, ID(RF off)=4.5A f=3.7 – 4.2GHz	41.5	42.5	-	dBm	
GLP	Linear Power Gain		9	11	-	dB	
ID	Drain current		-	4.5	-	A	
P.A.E.	Power added efficiency		-	32	-	%	
IM3 *2	3rd order IM distortion		-42	-45	-	dBc	
Rth(ch-c) *3	Thermal resistance		delta Vf method	-	-	1.9	°C/W

\*2 : item -51 , 2 tone test, Po=31 dBm Single Carrier Level , f=4.2GHz, delta f=5MHz

\*3 : Channel-case



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